July 2008

# FDW2502P

FAIRCHILD SEMICONDUCTOR

# Dual P-Channel 2.5V Specified PowerTrench<sup>®</sup> MOSFET

### **General Description**

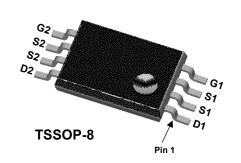
This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild's Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

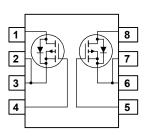
## Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

## Features

- -4.4 A, -20 V.  $R_{DS(ON)}$  = 35 m $\Omega$  @  $V_{GS}$  = -4.5 V  $R_{DS(ON)}$  = 57 m $\Omega$  @  $V_{GS}$  = -2.5 V.
- Extended  $V_{GSS}$  range (±12V) for battery applications.
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$  .
- Low profile TSSOP-8 package.





# Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-20	V
V <sub>GSS</sub>	Gate-Source Voltage		±12	V
I <sub>D</sub>	Drain Current – Continuous	(Note 1a)	-4.4	А
	– Pulsed		-30	
PD	Power Dissipation for Single Operation	(Note 1a)	1.0	W
		(Note 1b)	0.6	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	Il Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	125	°C/W
		(Note 1b)	208	

Device Marking	Device	Reel Size	Tape width	Quantity
2502P	FDW2502P	13"	12mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
-				. 76	mux	•
	acteristics				1	
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-14		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$ , $V_{GS} = 0 V$			-1	μA
I <sub>GSS</sub>	Gate–Body Leakage	$V_{GS}$ = ±12 V, $V_{DS}$ = 0 V			±100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-0.9	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		3.2		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V,  I_D = -4.4 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -4.4 \ , T_J = 125^\circ C \\ V_{GS} = -2.5 \ V,  I_D = -3.3 \ A \end{array} $		27 35 38	35 56 57	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -4.5 V$ , $V_{DS} = -5 V$	-30			A
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5 V$ , $I_{D} = -4.4 A$		18		S
Dvnamic	Characteristics					•
C <sub>iss</sub>	Input Capacitance			1465		pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = -10 V$ , $V_{GS} = 0 V$ ,	-	310		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0 MHz	-	155		pF
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = 15 mV, f = 1.0 MHz		7.7		Ω
Switchin	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time			14	25	ns
t <sub>r</sub>	Turn–On Rise Time	$V_{DD} = -10 V$ , $I_D = -1 A$ ,	-	8	16	ns
t <sub>d(off)</sub>	Turn–Off Delay Time	$V_{GS} = -4.5 \text{ V},  R_{GEN} = 6 \Omega$	-	51	82	ns
t <sub>f</sub>	Turn–Off Fall Time	1		29	47	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = -5 V$ , $I_D = -4.4 A$ , $V_{GS} = -5 V$		15	21	nC
Q <sub>gs</sub>	Gate-Source Charge	1		2.9		nC
Q <sub>gd</sub>	Gate-Drain Charge			3.5		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
t <sub>rr</sub>	Diode Reverse Recovery Time	$I_{\rm F} = -4.4  {\rm A},$		21		ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge	d <sub>iF</sub> /d <sub>t</sub> = 100 A/µs		8.1		nC
I <sub>s</sub>	Maximum Continuous Drain–Source	Diode Forward Current			-0.83	Α
-	Drain–Source Diode Forward	$V_{GS} = 0 V$ , $I_S = -0.83 A$ (Note 2)		-0.7	-1.2	v

### Notes:

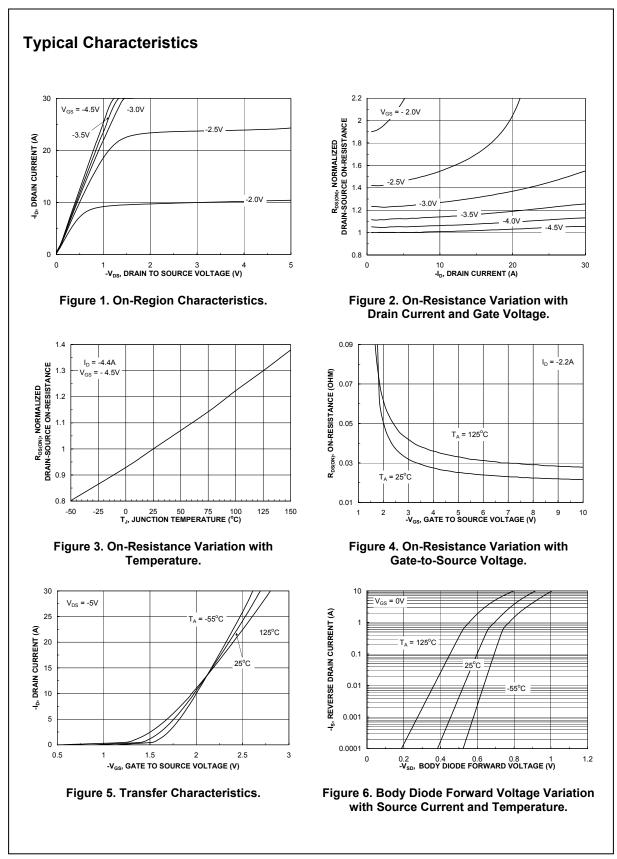
1.  $R_{0,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{0,JC}$  is guaranteed by design while  $R_{0,CA}$  is determined by the user's board design.

a)  $\rm R_{_{0JA}}$  is 125°C/W (steady state) when mounted on a 1 inch² copper pad on FR-4.

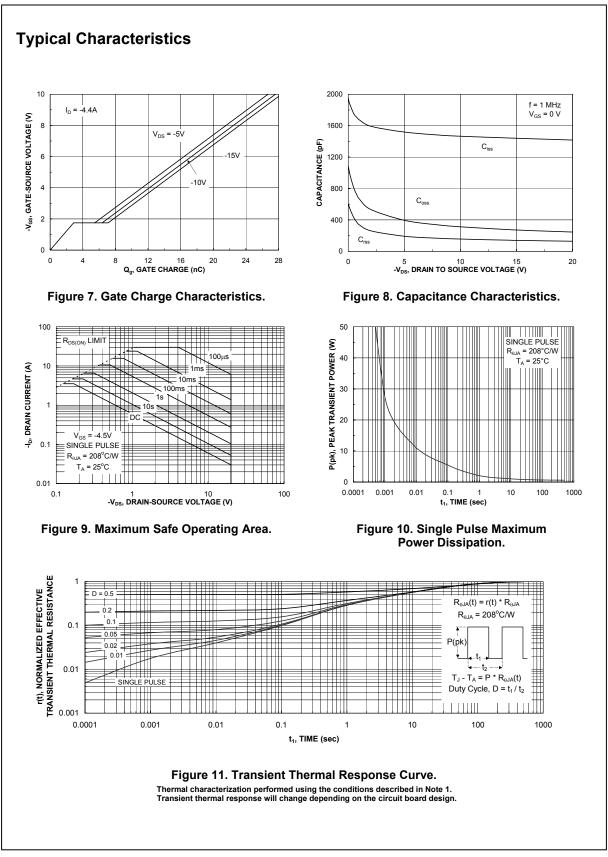
b) R<sub>0JA</sub> is 208°C/W (steady state) when mounted on a minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

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FDW2502P Rev. F1(W)



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